

Combinatorial Methodologies for Advanced Materials: An ATP Workshop

John D. Hewes, Ph.D.
Program Manager
Office of Chemical and Life Sciences

Richard W. Morris, Ph.D. Program Manager Office of Information Technologies

Advanced Technology Program

National Institute of Standards and Technology

Gaithersburg, MD

http://www.atp.nist.gov/www/ccmr/ccmr_off.htm

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce



Workshop Agenda

08:30 - 08:45 John Hewes (ATP) Workshop Kick-off

08:45 - 09:15 Peter Cohan (Symyx) "Implementation Issues"

09:15 - 09:30 Richard Morris (ATP) "Software Issues for Combinatorial Methods"

09:30 - 10:00 Doug Lenat (Cycorp) "Artificial Intelligence--Thesauri"

10:00 - 10:15 Break

10:15 - 10:45 Andrew Canning (LBNL): "Teraflop Computing for Advanced Materials"

10:45 - 11:15 David Dorsett (Symyx) "Datamining"

11:15 - 11:45 Rock Gnatovich, Spotfire "Visualization Tools"

11:45 – 12:15 Participant Discussion of Software Issues for Combinatorial Methods

12:15 - 13:30 Informal Lunch Discussion

13:30 – 13:45 John Hewes (ATP) "Hardware Issues for Combinatorial Methods"

13:45 - 14:15 Jim Cawse (GE CR&D) "Six Sigma in Combinatorial Methods"

14:15 - 14:45 MaryAnn Asaro (SRI) "Advances in Combinatorial Chemistry"

14:45 – 15:15 Pam York (Sarnoff) "Challenges in Lab-on-chip Technologies"

15:15 - 15:30 Break

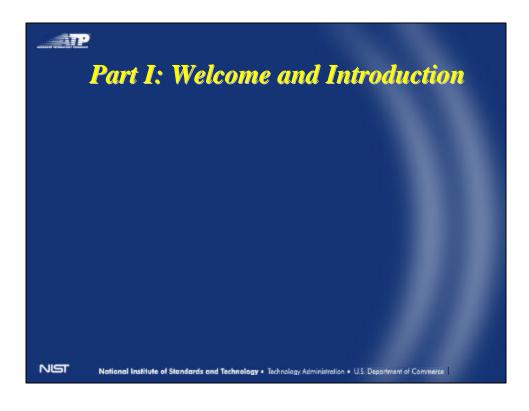
15:30 – 16:00 Joseph Hogan (Alveus Systems) "'Advances in Combinatorial Chemistry"

16:00 - 16:30 Selim Senkan (UCLA) "Combi Methods for Heterogeneous Catalysts"

16:30 - 17:00 Al Sylwester (Sandia) "Sandia's Micro Lab-on-Chip"

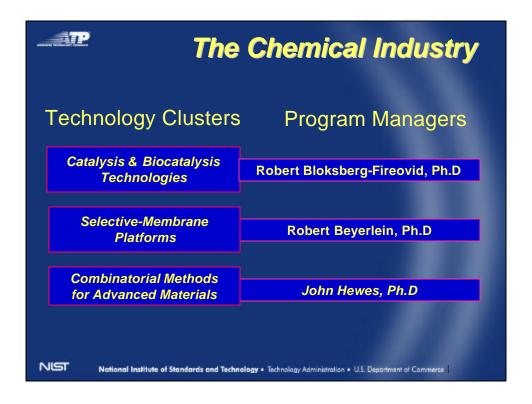
17:00 - 17:30 John Hewes (ATP) "Workshop Wrap-up"

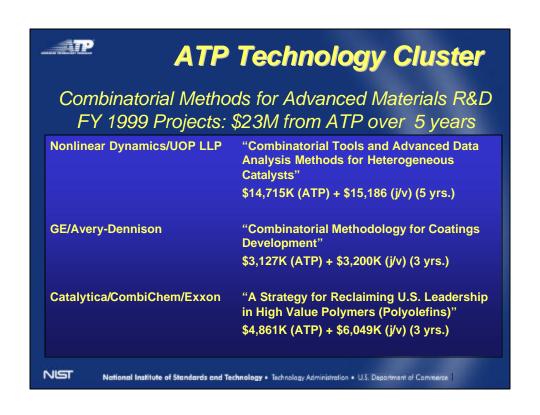
NIST

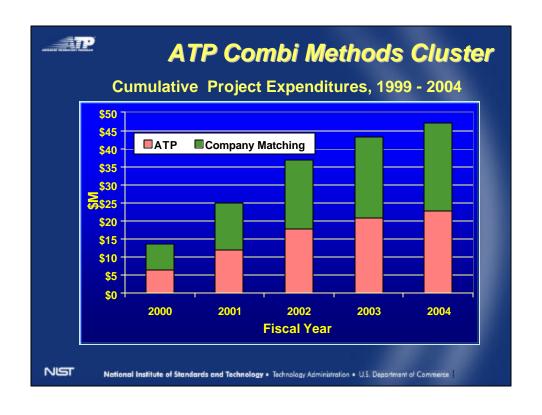




Total ATP Investment Electronics and Biotechnology (\$254M) Photonics (\$329M) Microelectronics **DNA Technologies Optics Technologies** Tissue Engineering **Drug Discovery Methods Power Technologies** Wireless Electronics **Proteomics Organic Electronics** Medical Devices & Imaging Information **Chemistry and Materials** Technology (\$389M) (\$344M) **Advanced Learning Systems** Component-Based Software Catalysis & Biocatalysis **Combinatorial Methods** Digital Video Information for Healthcare Separations/Membranes **Electronic Commerce** Nano-technology Engineered Surfaces **Dependable Computing Systems** Sensors Integration of Manufacturing Composites NIST National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce









Industry Drivers-Combi

- > Reduced innovation cycle times across organization
 - ✓ Discovery
 - ✓ Process and product development
 - ✓ Customer service and manufacturing
- ▶ More efficient use of capital for R&D and manufacturing
 - ✓ Time-to-market and ROI of R&D \$'s
- New products/new technologies = new markets
- Allows for "out-of-box" experimentation
 - ✓ Broadens spectrum of materials in development

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce



Competitive Threats

- Reverse engineering of intellectual property
- First-to-market, first-to-follow market positioning
- Faster response to customer needs
- Lower R&D cost structures, higher-performance
- Leverage of government funding

New compositions, faster, at lower R&D cost

NIST



Why Combi Methods Now?

- Strategic Inflection Points
- Horizontal Integration of computers & electronics
 - A. Groves, Only the Paranoid Survive

The New SIP: Outsourcing of Discovery, Lean R&D, Horizontal Distribution of Knowledge Capital

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce



Why ATP?

- Stimulate convergence of technologies
- Focused infrastructure development toward specific advanced materials applications
- Leverage leading-edge capabilities to lower-margin, less R&D-intensive industries than pharma
 - √ Timing is critical
 - ✓ Benefits firms of all sizes, with many alliances possible
 - ✓ Multi-Skill Center effort (broad synergies)
 - ✓ New tools for research and development
 - √ Large spill-over benefits to/from basic science

ATP can help U.S. industry implement!

75



Plan Forward—FY '00

Chemical/Materials industry identified two challenges for Discovery and Product & Process Development Processes

Informatics

- Design of the Library
- ✓ Computational/Modeling: QSPR
- ✓ Statistics and control of error
- ✓ Design of Experiments
- Informatics
- ✓ Increasing Information/Bandwidth
- √ Experimental complexity
- ✓ Data integration/analysis
- ✓ Hardware control
- √ Expert systems for data analysis

Micro-Characterization

- Screening
- ✓ MEMS: Lab-on-chip, Sensors
- ✓ Deposition/library fabrication
- √ Process control
 - Temperature/pressure
- √ Scalability Predictions
 - Interfacial properties
- Synthesis and Processing
- ✓ Automation: 10³-10⁴ samples
- ✓ Reproducibility
- √ Validation

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce

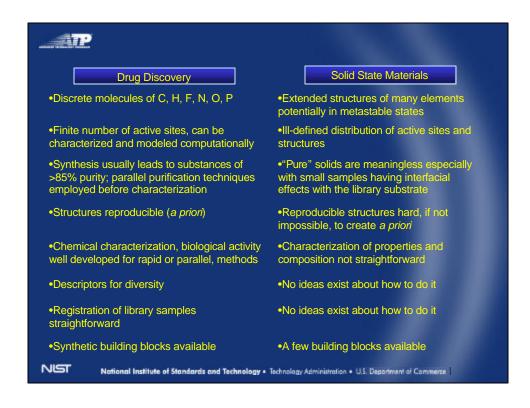


Part II: Characterization Issues

NIST

| MINISTER STREET | Enabling Technologies |
|----------------------|--|
| Design | Literature/Patent Data mining as input to library design Statistics, modeling, design of experiments Diversity analysis/clustering analysis Computational: Molecular Modeling, QSAR, QSPR |
| Fabrication | Chemical/Physical/Plasma Deposition Ink jet Thermally-driven deposition (e-beam, LEED, etc.) Laser ablation |
| Characterizat | Sample sizeunderstanding interfacial properties, diffusion, mass transport at micro-scale Mechanical and physical properties Error Identification On-line/Validation |
| Informatics | Data Mining, connectivity, parallelism, registration, |
| Syste | ems Integration is a Significant Challenge |
| NGT Notional Institu | te of Standards and Technology • Technology Administration • U.S. Department of Communic |

| Catalysts | | Structural materials | Metals and alloys |
|----------------------|---|------------------------------------|--|
| Electronic Materials | Polymers/Chemicals Phosphors Magnetic Materials Ceramics Semiconductors | | Composites Ceramics/metal oxide |
| Polymers | Membranes Encapsulants/packaging Adhesives Coatings | Glasses | Fibers Electronic Magnetic Optical |
| Biomaterials | Bio-sourced polymers Bio-compatible materials Bio-degradable polymers | Smart Materials Advanced Ceramics | Specialty |
| Optical materials | Coatings Photo-refractives Opto-electronics Non-Linear Optical materia | | Optical & Electronic Super-conducting Structural Coatings |



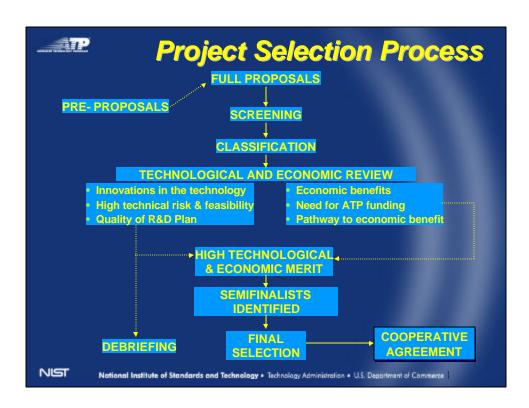


Issues--Characterization

- Miniaturization/parallelization of reaction, processing, and testing apparatus
- Micro-sensors (in situ analysis)
- High-level Integration
- Clear understanding of "scalability"
 - ✓ Validation of micro- vs. bulk properties
- Deposition of samples
 - ✓ Ink jet, PVD, CVD, etc.....

NIST







Rules for Participation ...

- Must produce U.S. economic benefits
 - ✓ R&D and manufacturing in the U.S.
 - ✓ Increase U.S. employment
 - √ Promote U.S. supplier infrastructure
- Companies incorporated in the U.S.
- Keep intellectual property rights
- Confidentiality (not subject to FOIA)
- Universities and non-profit research organizations may receive share of return from royalties but cannot own title to intellectual property

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce:

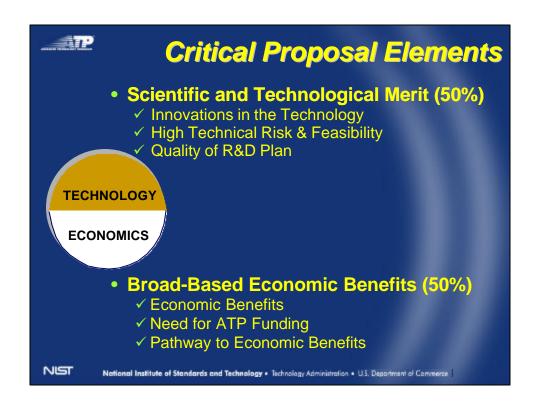


How to apply

- Pre-proposals--Year-round submission
- Full Proposals—Annual Competition
 - ✓ Announced late Fall, due early Spring
- Obtain and <u>read</u> the Preparation Kit
 - √ Hardcopy, online or CD-ROM
- Assemble Proposal
 - ✓ Commercialization <u>and</u> Technical Plans are evaluated by experts for feasibility
 - ✓ Multi-functional team highly recommended

Most Common Error is Lack of Detail in Proposal

NIST



Common Weaknesses

- Proposals lack of sufficient detail for peer review
 - √ How you will reach technical objectives
 - √ What's innovative about the approach
 - √ Why a risky technical approach is needed
- Proposals have unsupported assertions that project meets ATP's criteria
- Proposals miss ATP's window of opportunity
 - ✓ Low risk product development (too late)
 - ✓ Lacks demonstrated feasibility (too early)

NIST



Some helpful hints ...

- Proposals due at **3:00 p.m. (Eastern)** on the specified date -- *no fax or electronic transmittal*
- Late proposals rejected. NO EXCEPTIONS!
- Overnight mail companies sometimes don't deliver overnight
- Send your proposal in early
- Read the Proposal Prep Kit

NIST

National Institute of Standards and Technology • Technology Administration • U.S. Department of Commerce



Contact Information

www.atp.nist.gov

To Get on the ATP Mailing List:

Call toll-free: 800-ATP-FUND

(800-287-3863)

Fax your name and address to: (301) 926-9524

Send an e-mail message to: atp@nist.gov

NIST